

**18-Bit, Deglitched
Digital-to-Analog Converter**

FEATURES

- **18-Bit Resolution**
- **Deglitched Analog Output**
- **2nVsec Maximum Glitch Energy**
- **Bipolar +/-10V Output**
- **20 μ sec Settling Time to +/- 0.003%FSR**
- **Offset Binary Coding**
- **+/-0.00095%FSR INLE**
- **+/-0.00075%FSR DNLE**
- **0°C to +50°C Specified Temperature Range**

DESCRIPTION

The MN3390 is an 18-bit, deglitched-output, Digital-to-Analog converter designed for applications requiring high-resolution and glitch-free performance. The on-board deglitcher circuit reduces output glitch to 2nVsec maximum.

The MN3390 offers excellent performance characteristics. The device guarantees +/-0.00095%FSR Integral Linearity Error (INLE) and +/-0.00075%FSR Differential Linearity Error (DNLE). Initial offset error is specified at +/-5mV maximum and initial gain error is specified as +/-0.05% maximum. The device is specified for a 0°C to +50°C operating range.

The MN3390 provides a bipolar analog output of -10V to +10 V. Digital inputs are compatible with the HCT logic family. The MN3390 operates from standard +/-15 and +5V power supplies and consumes 1 Watt of power. The device is packaged in a hermetically-sealed, 32-pin DIP package.

APPLICATIONS

Magnetic Resonance Imaging
Robotics
Instrumentation
Process Control
ATE
Ion Beam Forming

MN3390 18-BIT DEGLITCHED D/A CONVERTER

ABSOLUTE MAXIMUM RATINGS

Operating Temperature Range	0°C to +70°C
Specified Temperature Range (case)	0°C to +50°C
Storage Temperature Range	-65°C to +70°C
+15 Volt Supply	-0.5 to +18 Volts
-15 Volt Supply	+0.5 to -18 Volts
+5 Volt Supply	-0.5 to +7.0Volts
Digital Inputs	-0.5 to +V _{DD} +0.5V

ORDERING INFORMATION

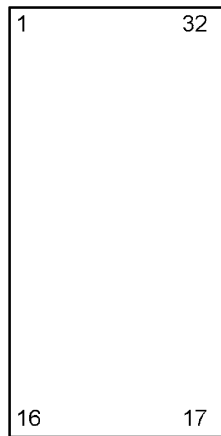
PART NUMBER	MN3390
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SPECIFICATIONS Typical at +25°C (unless otherwise indicated)

SPECIFICATIONS	MIN.	TYP.	MAX.	UNITS
DIGITAL INPUTS				
Logic Levels (All Inputs): Logic "1" Logic "0"	+2.0		+0.8	Volts Volts
Logic Currents: Digital Input Bits: Logic "1" @ V _{IH} =+5V Logic "0" @ V _{IL} =0V Latch Control: Logic "1" @ V _{IH} =+5V Logic "0" @ V _{IL} =0V S/H Control: Logic "1" @ V _{IH} =+5V Logic "0" @ V _{IL} =0V			+/-0.1 +/-0.1 +/-0.3 +/-0.3 +/-0.2 +/-0.2	μA μA μA μA μA μA
S/H Control: "Hold Mode" "Track Mode"		Logic "1" Logic "0"		
Latch Control: Transparent Latch		Logic "1" Logic "0"		
Digital Input Coding		Offset Binary		
ANALOG OUTPUT				
Output Voltage Range		+/-10		Volts
Output Current Load			+/-5	mA
Short Circuit Current		Protected		
Reference Output Voltage		+10		Volts
Reference Accuracy			+/-10	mV
TRANSFER CHARACTERISTICS				
Resolution		18		Bits
Integral Linearity Error Differential Linearity Error		+/-0.00075	+/-0.00095 +/-0.00075	%FSR %FSR
Offset Error		+/-2	+/-5	mV
Gain Error		+/-0.02	+/-0.05	%
Stability: Offset Drift Gain Drift		+/-0.05 +/-5		mV/°C ppm/°C
Warm-up Time	10			Minutes

DYNAMIC CHARACTERISTICS	MIN.	TYP.	MAX.	UNITS
Update Rate			200	kHz
Deglitcher Hold Time		1.7		μsec
Glitch Energy		0.7	2	nVsec
Settling Time: 1/2 Full Scale Step to +/-0.003%FSR 1 LSB Step to +/-0.00075%FSR			20 5	μsec μsec
POWER SUPPLIES				
Power Supply Range: +15V Supply -15V Supply +5V Supply	+14.550 -14.550 +4.75	+15.000 -15.000 +5.000	+15.450 -15.450 +5.25	Volts Volts Volts
Current Drains: +15V Supply -15V Supply +5V Supply		37 27 2	45 35 5	mA mA mA

PIN DESIGNATIONS



- | | |
|-------------------|-----------------------|
| 1. +5V Supply | 32. Analog Ground |
| 2. Digital Ground | 31. -15V Supply |
| 3. S/H Command | 30. +15V Supply |
| 4. Digital Ground | 29. Deglitched Output |
| 5. N.C. | 28. DAC Output |
| 6. N.C. | 27. Reference Output |
| 7. Latch Control | 26. N.C. |
| 8. Bit 18 (LSB) | 25. Bit 1 (MSB) |
| 9. Bit 17 | 24. Bit 2 |
| 10. Bit 16 | 23. Bit 3 |
| 11. Bit 15 | 22. Bit 4 |
| 12. Bit 14 | 21. Bit 5 |
| 13. Bit 13 | 20. Bit 6 |
| 14. Bit 12 | 19. Bit 7 |
| 15. Bit 11 | 18. Bit 8 |
| 16. Bit 10 | 17. Bit 9 |

APPLICATIONS INFORMATION

LAYOUT, GROUNDING AND DECOUPLING -

Proper attention to layout, grounding and decoupling is required to obtain specified linearity and accuracy from the MN3390. It is critically important that power supplies be filtered, well-regulated, and free from high-frequency noise. Use of noisy supplies can easily degrade the device's performance and cause unstable output levels to be generated. Switching power supplies are not recommended for circuits attempting to achieve 12-bit or greater accuracy unless great

care is used in filtering any switching spikes present in their output.

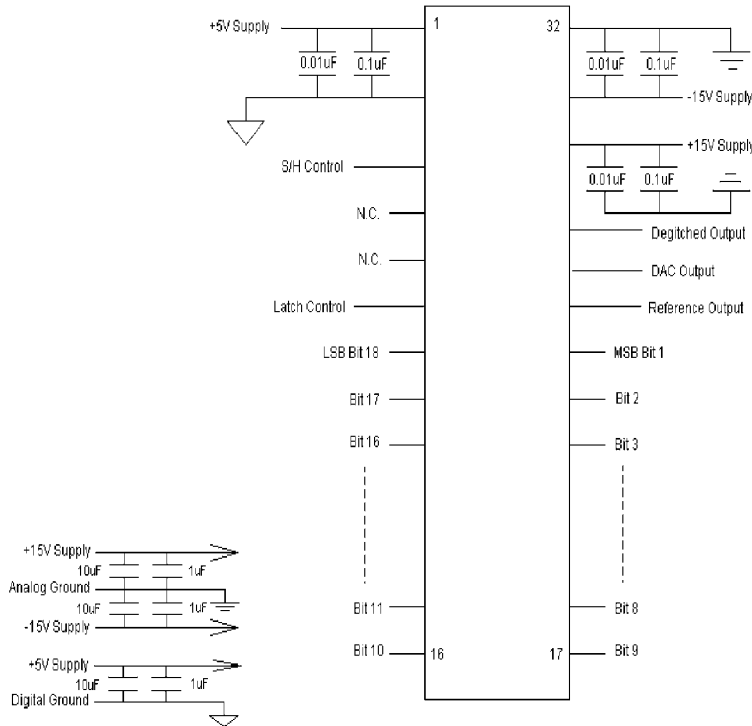
The MN3390's digital ground pins (pins 2 and 4) are not connected internally to the device's analog ground pin (pin 32). These pins should be tied together at the device to a large-area, low-impedance analog ground plane beneath the device.

Power supply connections should be short and direct, and all supply lines should be decoupled (bypassed) with tantalum or electrolytic

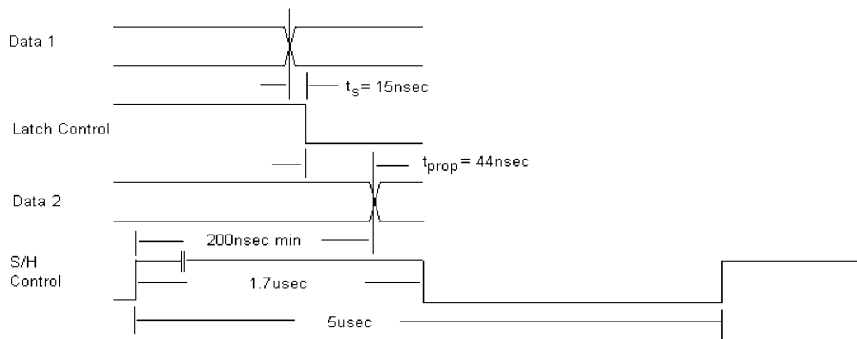
capacitors located on board close to the MN3390. For optimum performance, a relatively large value tantalum (1-10 μ F) capacitor paralleled with a smaller (0.01 to 0.1 μ F) ceramic disc capacitor should be used as shown in the diagram below.

Coupling between digital inputs and analog output should be minimized to avoid noise pick-up. Care should be utilized to avoid long runs of digital signals close to analog runs.

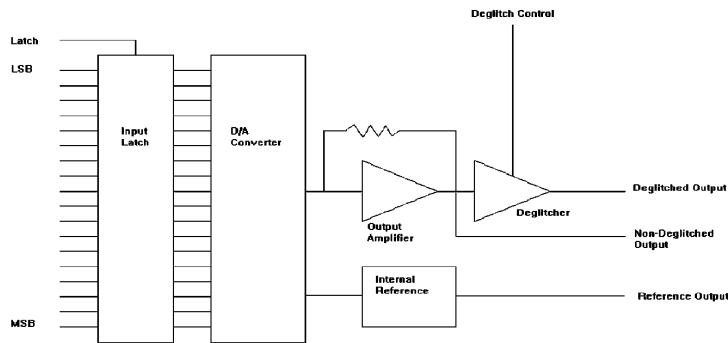
APPLICATIONS DIAGRAM



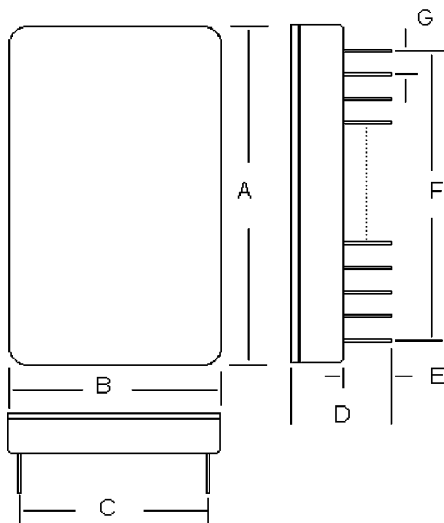
TIMING DIAGRAM



BLOCK DIAGRAM



PACKAGE OUTLINE



Dimension	Inches		Millimeters	
	Min	Max	Min	Max
A		1.740		44.20
B		1.140		28.96
C	0.900 typ		22.86 typ	
D		0.425		10.80
E	0.195	0.215	4.95	5.46
F	1.50 typ		38.1 typ	
G	0.100 typ		2.54 typ	